### TOSHIBA PHOTOCOUPLER PHOTO RELAY

# **TLP3118**

#### Measurement Instruments

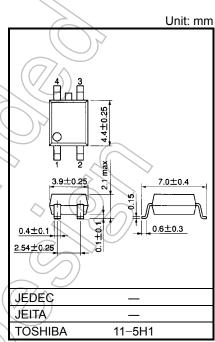
The TOSHIBA TLP3118 mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP3118 consists of an infrared-emitting diode optically coupled to a photo-MOSFET and is housed in a  $4-\sqrt{100}$  pin package.

#### **Features**

- 4-pin SOP (2.54SOP4): 2.1 mm high, 2.54 mm pitch
- 1-Form-A
- Peak Off-State Voltage: 80 V (min)
- Trigger LED Current: 3 mA (max)
- On-State Current: 40 mA (max)
- On-State Resistance:  $25 \Omega$  (max)
- Output Capacitance: 3.5 pF (max)
- Isolation Voltage: 1500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A

File No.E67349

VDE-approved: EN 60747-5-5 (Note 1)

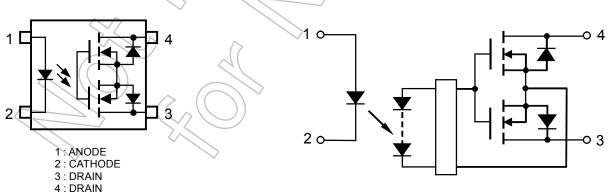


Weight: 0.1 g (typ.)

Note 1: When a VDE approved type is needed, please designate the **Option(V4)**.

# Pin Configuration (Top View)

#### Schematic



Start of commercial production 2004-10

### **Absolute Maximum Ratings (Ta = 25°C)**

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	lF	50	mA
	Forward Current Derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C
Ω	Reverse Voltage	VR	5	V
LED	Diode Power Dissipation	P <sub>D</sub>	50	mW
	Diode Power Dissipation Derating (Ta ≥25°C)	ΔP <sub>D</sub> /°C	-0.5	mW/°C
	Junction Temperature	Tj	125	(%)
	Off-State Output Terminal Voltage	Voff	80	
~	On-State Current	Ion	40	mA
CTO	On-State Current Derating (Ta ≥ 25°C)	Δl <sub>ON</sub> /°C	-0.4	mA/°C
DETECTOR	Output Power Dissipation	Po	40	mW
	Output Power Dissipation Derating (Ta ≥ 25°C)	ΔP <sub>o</sub> /°C	-0.4	mW / °C
	Junction Temperature	Tj	125	°C
Stora	ge Temperature Range	T <sub>stg</sub>	-40 to 125	°C _
Opera	ating Temperature Range	Topr	-20 to 85	°C
Lead	Soldering Temperature (10 s)	Tso	260	(°C/
Isolat	ion Voltage (AC, 60 s, R.H. $\leq$ (60 %) (Note 1)	BVs	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: Pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

#### Caution

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

### **Recommended Operating Conditions**

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	$V_{DD}$	_	_	64	V
Forward Current	l <sub>F</sub>	5	_	30	mA
On-State Current	Ion	_	_	40	mA
Operating Temperature	T <sub>opr</sub>	25	_	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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# Individual Electrical Characteristics (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μΑ
	Capacitance between terminals	CT	V <sub>F</sub> = 0 V, f = 1 MHz	2	15	_	pF
STOR	Off-State Current	loff	V <sub>OFF</sub> = 80 V, Ta = 60 °C	+	/P	1	nA
DETECTOR	Capacitance between terminals	COFF	V = 0 V, f = 100 MHz, t < 1 s		2.5	3.5	pF

### **Coupled Electrical Characteristics (Ta = 25°C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP. MAX	UNIT
Trigger LED Current	I <sub>FT</sub>	I <sub>ON</sub> = 40 mA		3	mA
Return LED Current	I <sub>FC</sub>	I <sub>OFF</sub> = 10 μA	♦0.1	9-100 -	mA
On-State Resistance	Ron	$I_{ON} = 40 \text{ mA}, I_F = 5 \text{ mA}, t < 1 \text{ s}$		16 25	Ω

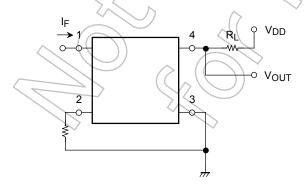
# **Isolation Characteristics (Ta = 25°C)**

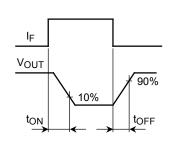
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance Input to Output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation Resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation Voltage	BVS	AC, 60 s	1500	_	_	Vrms

### Switching Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Turn-on Time	ton	$R_L = 200 \Omega$ (Note 2)	1	0.07	0.5	mo
Turn-off Time	tore	$V_{DD} = 10 \text{ V, IF} = 5 \text{ mA}$	_	0.07	0.5	ms

(Note 2): Switching time test circuit

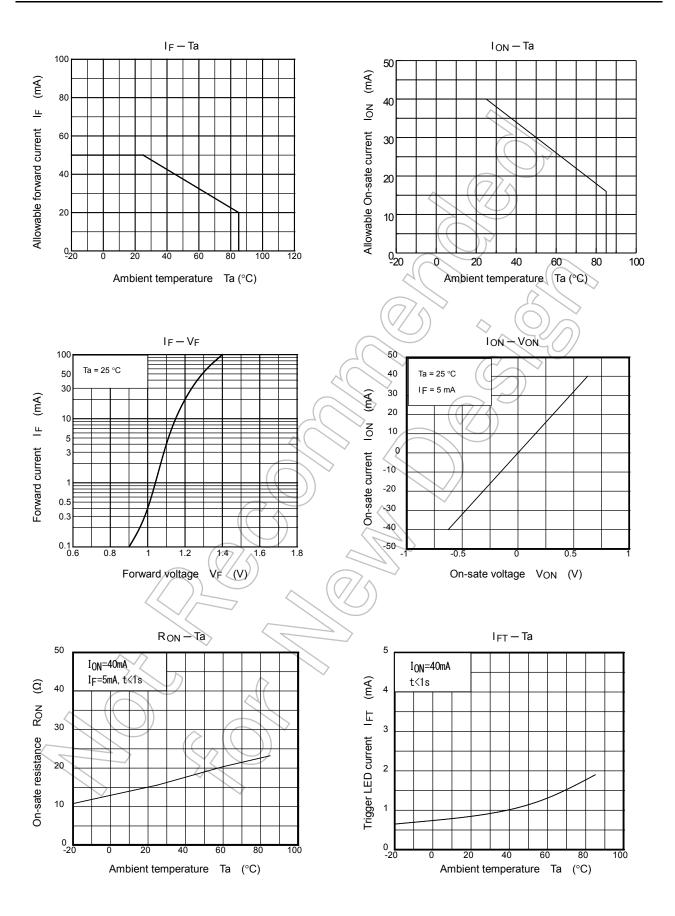




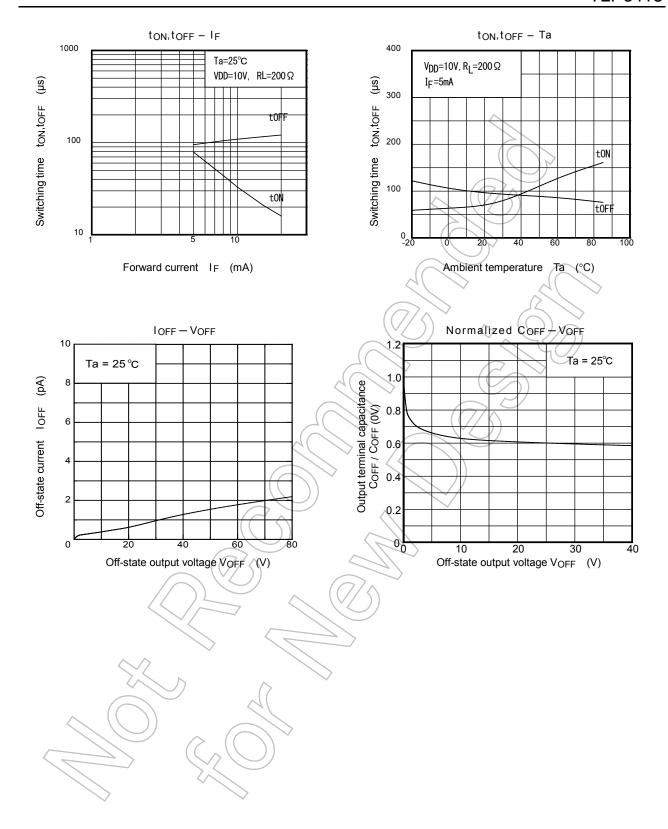
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NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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